RTQ030P02

Transistor

DC-DC Converter (-20V, -3.0A)

RTQ030P02

Features

- 1) Low On-resistance.(110m Ω at 2.5V)
- 2) High Power Package.
- 3) High speed switching.
- WWW.DZSC.COM 4) Low voltage drive.(2.5V)

Applications

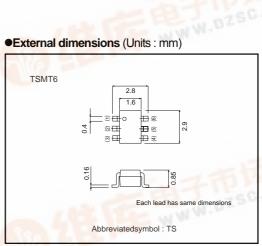
DC-DC converter

Structure

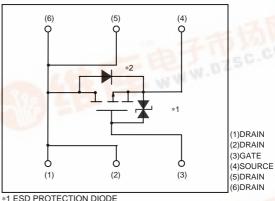
Silicon P-channel **MOSFET**

Packaging specifications

Туре	Package	Taping
	Code	TR
	Basic ordering unit (pieces)	3000
RTQ030P02	0	



Equivalent circuit



*1 ESD PROTECTION DIODE

*2 BODY DIODE





● Absolute maximum ratings (Ta=25°C)

Parameter		Symbol Limits		Unit	
Drain-source voltage		Voss	-20	V	
Gate-source voltage		Vgss	±12	V	
Drain current	Continuous	lσ	±3	A	
	Pulsed	IDP	±12	A *1	
Source current (Body diode)	Continuous	ls	-1	А	
	Pulsed	Isp	-4	A *1	
Total power dissipation		Po	1.25	W*2	
Channel temperature		Tch	150	°C	
Range of Storage temperature		Tstg	-55~+150	°C	

^{*1} Pw≦10μs, Duty cycle≦1% *2 Mounted on a ceramic board

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Gate-source leakage	Igss	_	-	±10	μА	Vgs=±12V, Vps=0V	
Drain-source breakdown voltage	V(BR)DSS	-20	-	-	V	In=-1mA, VGS=0V	
Zero gate voltage drain current	IDSS	-	-	-1	μА	V _{DS} =-20V, V _{GS} =0V	
Gate threshold voltage	VGS(th)	-0.7	_	-2.0	V	V _{DS} =-10V, I _D =-1mA	
Static drain-source on-state resistance	RDS(on)	-	60	80	mΩ	In=-3A, Vgs=-4.5V	
		_	65	90	mΩ	In=-3A, Vgs=-4V	
		-	110	150	mΩ	ID=-1.5A, VGS=-2.5V	
Foward transfer admittance	Y _{fs} *	2.0	_	_	S	Vps=-10V, Ip=-1.5A	
Input capacitance	Ciss	_	800	-	pF	V _{DS} =-10V,V _{GS} =0V f=1MHz	
Output capacitance	Coss	i	150	_	pF		
Reverse transfer capacitance	Crss	_	100	-	pF	1-111112	
Turn-on delay time	td(on) *	-	15	_	ns	1 454	
Rise time	tr *	i	27	_	ns	- I _D =−1.5A V _D D	
Turn-off delay time	td(off) *	-	50	_	ns	V _G S=-4.5V R _L =10Ω	
Fall time	t _f *	1	20	-	ns	$R_{GS}=10\Omega$	
Total gate charge	Qg	_	9.0	_	nC	V _{DD} ≒−15V V _{GS} =−4.5V I _D =−3A	
Gate-source charge	Qgs	-	1.6	-	nC		
Gate-drain charge	Qgd	1	4.6	_	nC		
*PULSED Body diode characteristics (source-drain characteristics)							
Forward voltage	VSD	_	_	-1.2	V	Is=-1A, Vgs=0V	

	•						
Forward voltage		VSD	_	-	-1.2	V	Is=-1A, Vgs=0V



Electrical characteristic curves

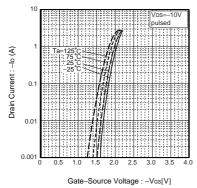


Fig.1 Typical Transfer Characteristics

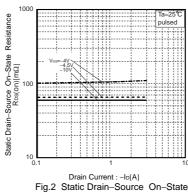


Fig.2 Static Drain-Source On-State Resistance vs. Drain Current

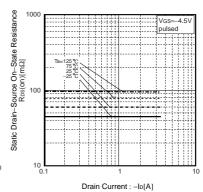


Fig.3 Static Drain-Source On-State Resistance vs.Drain Current

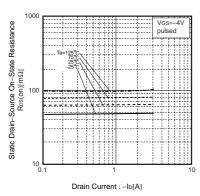


Fig.4 Static Drain-Source On-State Resistance vs.Drain-Current

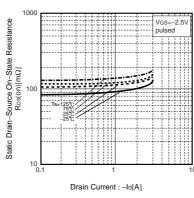


Fig.5 Static Drain-Source On-State Resistance vs. Drain-Current

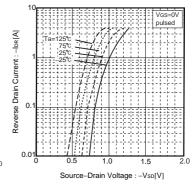


Fig.6 Reverse Drain Current vs. Source-Drain Voltage

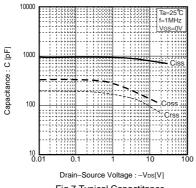


Fig.7 Typical Capactitance vs.Drain-Source Voltage

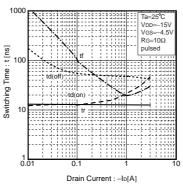


Fig.8 Switching Characteristics

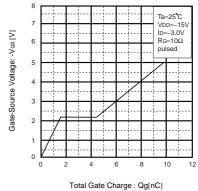


Fig.9 Dynamic Input Characteristics

Measurement circuits

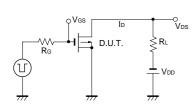


Fig.10 Switching Time Measurement Circuit

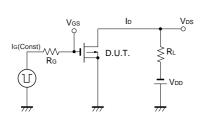


Fig.12 Gate Charge Measurement Circuit

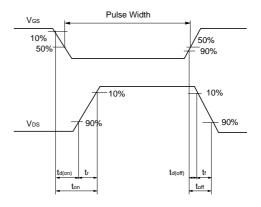


Fig.11 Switching Waveforms

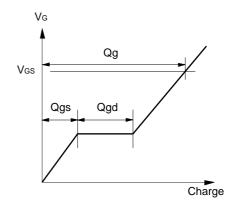


Fig.13 Gate Charge Waveforms

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